

## C L A I M S

1. Substrate sections which have been rendered pressure-sensitive adhesive and sealed in bags so as to be protected against loss of active substance, the pressure-sensitive adhesive surface of which is covered by a carrier layer which projects at least partially beyond said substrate sections and is divided by an incision, thus forming a detachment aid, through which incision adhesive may leak out in cold flow during storage and may cause the substrate section to stick to the bag, characterized in that in order to increase storage stability by avoiding leakage of pressure-sensitive adhesive, the carrier layer is configured with two carrier layer sections which overlap each other in the region where they are joined.

2. Substrate section according to Claim 1, characterized in that one of the carrier layer sections is wider than the other section by the amount of the overlap.

3. Substrate section according to Claim 1, characterized in that both carrier layer sections are, by the amount of half the overlap, wider than half the width dimension of an undivided carrier layer.

4. Substrate section according to Claims 1 to 3, characterized in that the region of overlap is positioned centrally or eccentrically on the substrate section.

5. Process for forming substrate sections comprising carrier layer sections projecting beyond the substrate sections and forming a region of overlap, characterized in that the pressure-sensitive adhesive substrate sections are supplied via a dispensing process to the carrier layer sections after the latter have been overlapped.

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